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## NTE74HCT138 Integrated Circuit TTL – High Speed CMOS, 3-to-8 Line Decoder

**Description:**

The NTE74HCT138 is a 3-to-8 line decoder in a 16-Lead plastic DIP type package that utilizes advanced silicon-gate CMOS technology and is well suited for memory address decoding and data routing applications. This device features high noise immunity and low power consumption usually associated with CMOS circuitry, yet has speeds comparable to low power Schottky TTL logic.

The NTE74HCT138 has 3 binary select inputs (A, B, and C). If the device is enabled, these inputs determine which one of the eight normally HIGH outputs will go LOW. Two active LOW and one active HIGH enables (G1, G2A, and G2B) are provided to ease the cascading decoders.

The decoders' output can drive 10 low power Schottky TTL equivalent loads and are functionally and pin equivalent to the NTE74LS138. All inputs are protected from damage due to static discharge by diodes to V<sub>CC</sub> and GND.

The NTE74HCT138 is intended to interface between TTL and NMOS components and standard CMOS devices. This device is also a plug-in replacement for LS-TTL devices and can be used to reduce power consumption in existing designs.

**Features:**

- TTL Pinout Compatible
- Propagation Delay: 20ns (typ)
- Low Quiescent Current: 80µA (max)
- Low Input Current: 1µA (max)
- Fanout of 10 LS-TTL Loads

**Absolute Maximum Ratings:** (Note 1, Note 2)

Supply Voltage, V <sub>CC</sub> .....	-0.5 to +7.0V
DC Input Voltage, V <sub>IN</sub> .....	-1.5 to V <sub>CC</sub> +1.5V
DC Output Voltage, V <sub>OUT</sub> .....	-0.5 to V <sub>CC</sub> + 0.5V
Clamp Diode Current, I <sub>IK</sub> , I <sub>OK</sub> .....	±20mA
DC Output Current (Per Pin), I <sub>OUT</sub> .....	±25mA
DC V <sub>CC</sub> or GND Current (Per Pin), I <sub>CC</sub> .....	±50mA
Power Dissipation (Note 3), P <sub>D</sub> .....	600mW
Storage Temperature Range, T <sub>stg</sub> .....	-65°C to +150°C
Lead Temperature (During Soldering, 10sec), T <sub>L</sub> .....	+260°C

Note 1. Absolute Maximum Ratings are those values beyond which damage to the device may occur.  
 Note 2. Unless otherwise specified, all voltages are referenced to GND.  
 Note 3. Power Dissipation temperature derating: 12mW/°C from +65°C to +85°C.

### Recommended Operating Conditions:

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	$V_{CC}$	4.5	–	5.5	V
DC Input or Output Voltage	$V_{IN}, V_{OUT}$	0	–	$V_{CC}$	V
Operating Temperature Range	$T_A$	–40	–	+85	°C
Input Rise or Fall Times	$t_r, t_f$	–	–	500	ns

### DC Electrical Characteristics: ( $V_{CC} = 5V \pm 10\%$ unless otherwise specified)

Parameter	Symbol	Test Conditions	$T_A = +25^\circ\text{C}$		Unit		
			Typ	Guaranteed Limits			
Minimum High Level Input Voltage	$V_{IH}$		–	2.0	2.0	V	
Maximum Low Level Input Voltage	$V_{IL}$		–	0.8	0.8	V	
Minimum High Level Output Voltage	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$ I_{OUT}  = 20\mu\text{A}$	$V_{CC}$	$V_{CC}^{-0.1}$	$V_{CC}^{-0.1}$	V
			$ I_{OUT}  = 4.0\text{mA}, V_{CC} = 4.5\text{V}$	4.2	3.98	3.84	V
			$ I_{OUT}  = 4.8\text{mA}, V_{CC} = 5.5\text{V}$	5.2	4.98	4.84	V
Minimum Low Level Output Voltage	$V_{OL}$	$V_{IN} = V_{IH}$	$ I_{OUT}  = 20\mu\text{A}$	0	0.1	0.1	V
			$ I_{OUT}  = 4.0\text{mA}, V_{CC} = 4.5\text{V}$	0.2	0.26	0.33	V
			$ I_{OUT}  = 4.8\text{mA}, V_{CC} = 5.5\text{V}$	0.2	0.26	0.33	V
Maximum Input Current	$I_{IN}$	$V_{IN} = V_{CC}$ or GND, $V_{IH}$ or $V_{IL}$	–	$\pm 0.1$	$\pm 1.0$	$\mu\text{A}$	
Maximum Quiescent Supply Current	$I_{CC}$	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu\text{A}$	–	8.0	80	$\mu\text{A}$	
		$V_{IN} = 2.4\text{V}$ or $0.5\text{V}$ , Note 4	–	0.3	0.4	mA	

Note 4. This is measured per input with all other inputs held at  $V_{CC}$  or GND.

### AC Electrical Characteristics: ( $V_{CC} = 5V$ , $t_r = t_f = 6\text{ns}$ , $C_L = 15\text{pF}$ , $T_A = +25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Typ	Guaranteed Limits	Unit
Maximum Propagation Delay (A, B, or C to Output)	$t_{PHL}$		20	35	ns
	$t_{PLH}$		13	25	ns
Maximum Propagation Delay (G1 to Y Output)	$t_{PHL}$		14	25	ns
	$t_{PLH}$		13	25	ns
Maximum Propagation Delay (G2A or G2B to Y Output)	$t_{PHL}$		17	30	ns
	$t_{PLH}$		13	25	ns

### AC Electrical Characteristics: ( $V_{CC} = 5V \pm 10\%$ , $t_r = t_f = 6\text{ns}$ , $C_L = 50\text{pF}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	$T_A = +25^\circ\text{C}$		Unit	
			Typ	Guaranteed Limits		
Maximum Propagation Delay (A, B, or C to Output)	$t_{PHL}$		24	40	50	ns
	$t_{PLH}$		18	30	38	ns
Maximum Propagation Delay (G1 to Y Output)	$t_{PHL}$		17	30	38	ns
	$t_{PLH}$		20	30	38	ns
Maximum Propagation Delay (G2A or G2B to Y Output)	$t_{PHL}$		23	35	43	ns
	$t_{PLH}$		18	30	38	ns

**AC Electrical Characteristics (Cont'd):** ( $V_{CC} = 5V \pm 10\%$ ,  $t_r = t_f = 6ns$ ,  $C_L = 50pF$  unless otherwise specified)

Parameter	Symbol	Test Conditions	$T_A = +25^\circ C$		$T_A = -40^\circ \text{ to } +85^\circ C$		Unit
			Typ	Guaranteed Limits			
Maximum Output Rise and Fall Time	$t_{THL}, t_{TLH}$		-	15	19		ns
Power Dissipation Capacitance	$C_{PD}$	Note 5	55	-	-		pF
Input Capacitance	$C_{IN}$		-	5	10		pF

Note 5.  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

**Truth Table:**

Inputs					Outputs							
Enable		Select			Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
G1	$\overline{G2}$ (Note 6)	C	B	A								
X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	H	H	H	H	H	L	H	H	H	H
H	L	H	L	L	H	H	H	H	L	H	H	H
H	L	H	L	H	H	H	H	H	H	L	H	H
H	L	H	H	L	H	H	H	H	H	H	L	H
H	L	H	H	H	H	H	H	H	H	H	H	L

Note 6.  $\overline{G2} = \overline{G2A} + \overline{G2B}$

H = HIGH Level

L = LOW Level

X = Don't Care

**Pin Connection Diagram**



